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Each author must submit a separate form and is personally responsible for the accuracy and completeness of the submitted information. It is essential that all authors take this responsibility seriously to maintain trust in the scientific community.

At the time of manuscript acceptance, journals will ask authors to confirm, and if necessary, update their disclosure statements. This ensures that any changes in potential conflicts of interest are reflected accurately. Occasionally, journals may request additional information about reported relationships to ensure clarity and transparency.

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This enhanced version emphasizes the importance of transparency and accuracy in disclosing potential conflicts of interest, ensuring that authors understand their role in maintaining the integrity of the research.

The form is in six parts.

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